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**PATENT APPLICATION**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Shinya NAKAI

Group Art Unit: 2618

Application No.: 10/774,606

Examiner: N. VO

Filed: February 10, 2004

Docket No.: 118621

For: FRONT END MODULE AND HIGH-FREQUENCY FUNCTIONAL MODULE

**REQUEST FOR RECONSIDERATION**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In reply to the June 17, 2008 Office Action, reconsideration of the application is respectfully requested in light of the following remarks.

Claims 6 and 7 are pending in this application.

The Office Action rejects claims 6 and 7 under 35 U.S.C. §103(a) over U.S. Patent Publication No. 2002/0090974 to Hagn in view of U.S. Patent No. 5,786,738 to Ikata and U.S. Patent Publication No. 2002/0030555 to Mandai. This rejection is respectfully traversed.

The Office Action recognizes that the combination of Hagn and Ikata does not disclose all elements recited in claim 6. In particular, the Office Action admits that "Hagn as modified by Ikata fails to disclose that the duplexer includes a chip or two chips including the acoustic wave elements and mounted on the multi-layer substrate, and the multi-layer substrate includes components of the duplexer except the acoustic wave elements." See the Office Action at page 3, lines 13-16.